

**$V_{RM} = 600\text{ V}$ ,  $I_{F(AV)} = 60\text{ A}$ ,  $t_{rr} = 100\text{ ns}$**   
**Fast Recovery Diode**  
**FMNS-4606S**

**Description**

The FMNS-4606S is a 600 V, 60 A, fast recovery diode. The maximum  $V_F$  of 1.3 V and the maximum  $t_{rr}$  of 100 ns ( $I_F : I_{RP} = 1 : 2$ ) are realized by optimizing the trade-off relationship between  $V_F$  and  $t_{rr}$ . The low thermal resistance package achieves high performance in terms of heat dissipation.

**Features**

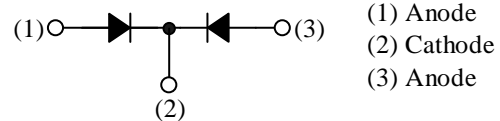
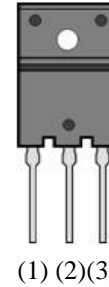
- $V_{RM}$ ----- 600 V
- $I_{F(AV)}$ ----- 60 A
- $V_F$ ----- 1.3 V
- $t_{rr1} (I_F = I_{RP})$ ----- 150 ns
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

**Applications**

- PFC Circuit
- Inverter Circuit
- Secondary-side Rectifier Diode  
(Flyback Converter, LLC Converter, etc.)
- Freewheel Diode  
(Offline Buck Converter, Offline Buck-boost Converter, etc.)

**Package**

TO3PF-3L



Not to scale

**Absolute Maximum Ratings**

 Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$ .

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	$V_{RSM}$		600	V
Repetitive Peak Reverse Voltage	$V_{RM}$		600	V
Average Forward Current	$I_{F(AV)}$	See Figure 1 and Figure 2	60	A
Surge Forward Current	$I_{FSM}$	Half cycle sine wave, positive side, 10 ms, 1 shot	200	A
$I^2t$ Limiting Value	$I^2t$	$1\text{ ms} \leq t \leq 10\text{ ms}$	200	$\text{A}^2\text{s}$
Junction Temperature	$T_J$		-40 to 150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$		-40 to 150	$^\circ\text{C}$

**Electrical Characteristics**

 Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$ .

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop <sup>(1)</sup>	$V_F$	$T_J = 25\text{ }^\circ\text{C}$ , $I_F = 30\text{ A}$	—	—	1.3	V
Reverse Leakage Current <sup>(1)</sup>	$I_R$	$V_R = V_{RM}$	—	—	200	$\mu\text{A}$
Reverse Leakage Current under High Temperature <sup>(1)</sup>	$H \cdot I_R$	$V_R = V_{RM}$ , $T_J = 150\text{ }^\circ\text{C}$	—	—	20	mA
Reverse Recovery Time <sup>(1)</sup>	$t_{rr1}$	$I_F = I_{RP} = 500\text{ mA}$ , 90% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	150	ns
	$t_{rr2}$	$I_F = 500\text{ mA}$ , $I_{RP} = 1\text{ A}$ , 75% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	100	ns
Thermal Resistance <sup>(2)</sup>	$R_{th(J-C)}$		—	—	1.7	$^\circ\text{C/W}$

**Mechanical Characteristics**

Parameter	Conditions	Min.	Typ.	Max.	Unit
Heatsink Mounting Screw Torque		0.686	—	0.882	N·m

<sup>(1)</sup> The rating of one chip.

<sup>(2)</sup>  $R_{th(J-C)}$  is thermal resistance between junction and case.

Rating and Characteristic Curves

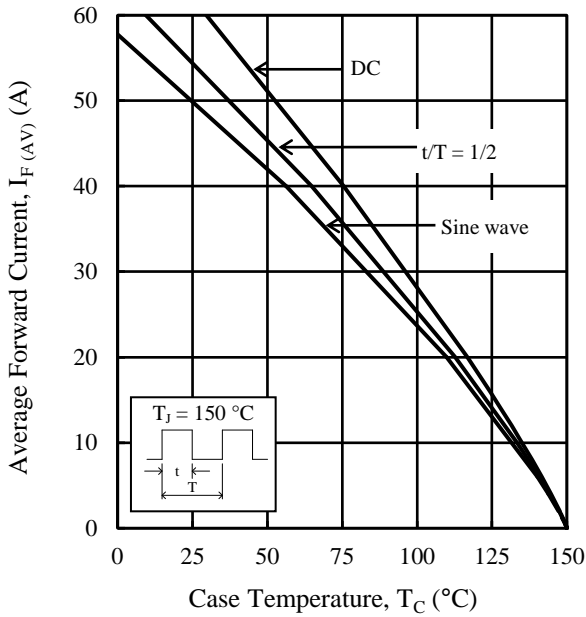


Figure 1. Typical Characteristics:  $I_{F(AV)}$  vs.  $T_C$  ( $V_R = 0\text{ V}$ )

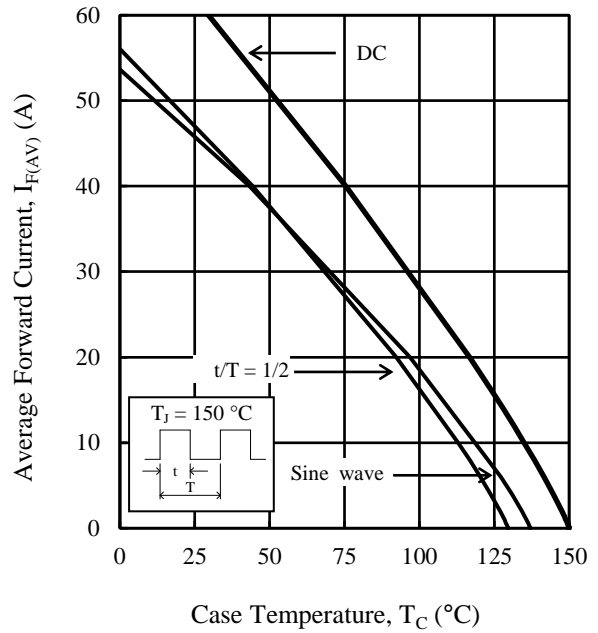


Figure 2. Typical Characteristics:  $I_{F(AV)}$  vs.  $T_C$  ( $V_R = 600\text{ V}$ )

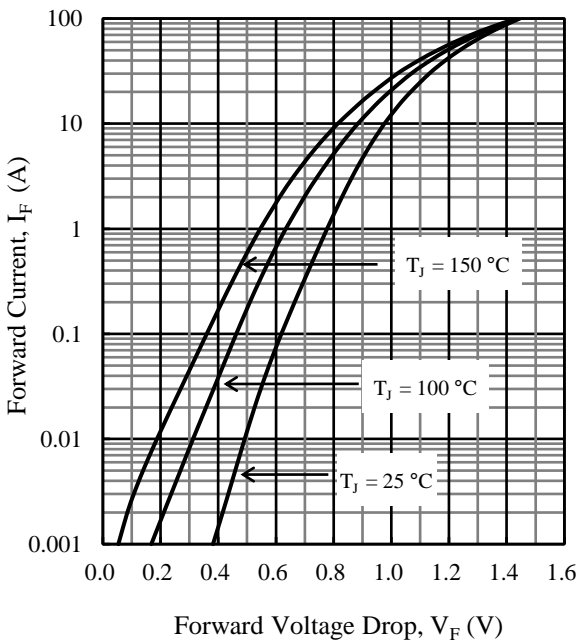


Figure 3. Typical Characteristics:  $I_F$  vs.  $V_F$

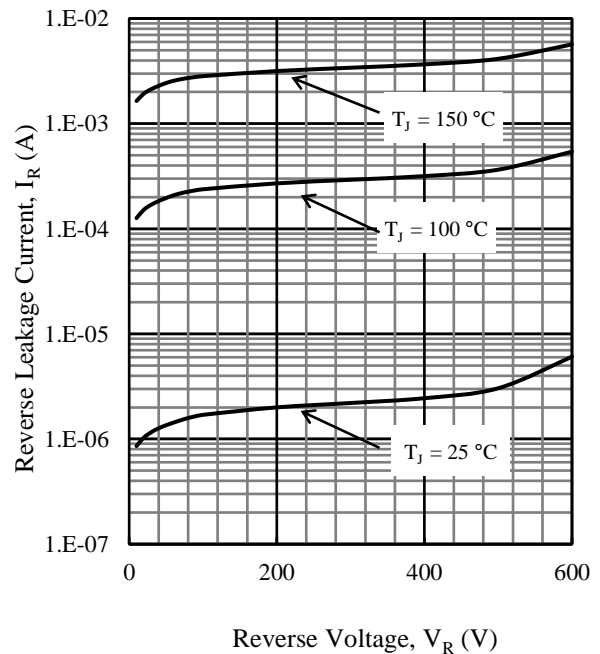
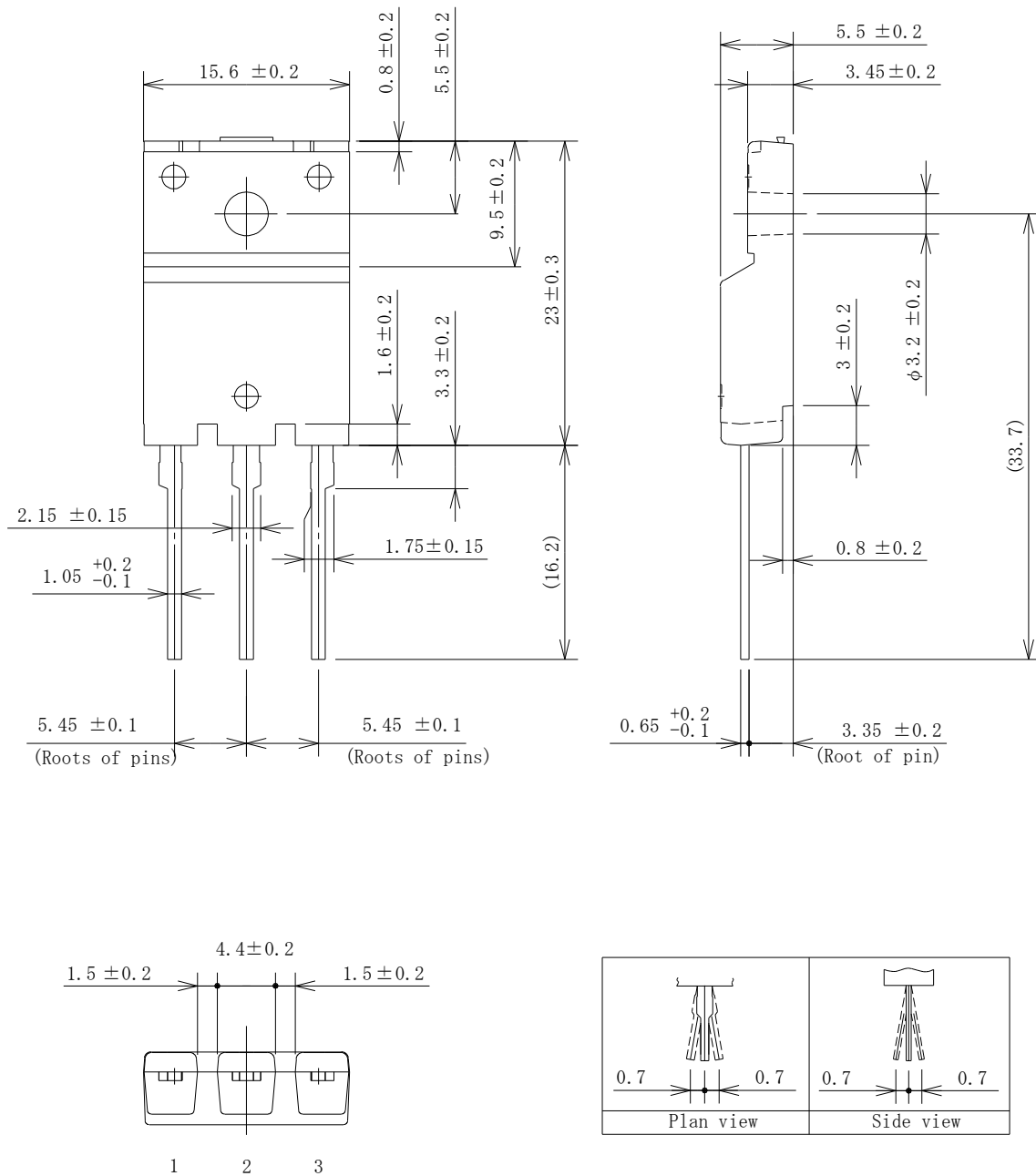


Figure 4. Typical Characteristics:  $I_R$  vs.  $V_R$

Physical Dimensions

• TO3PF-3L



NOTES:

- Dimensions in millimeters.
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:  
 Flow:  $260 \pm 5$  °C /  $10 \pm 1$  s, 2 times  
 Soldering Iron:  $380 \pm 10$  °C /  $3.5 \pm 0.5$  s, 1 time  
 Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram

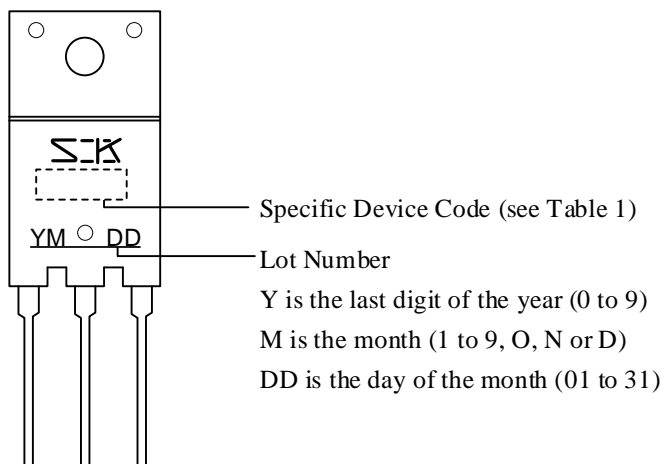


Table 1. Specific Device Code

Specific Device Code	Part Number
NS4606	FMNS-4606S

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